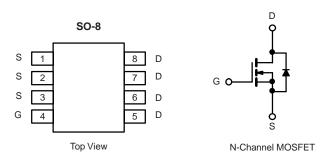


N-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^d	Q _g (Typ.)		
60	0.025 at V _{GS} = 10 V	7.6	10.5 nC		
00	0.030 at V _{GS} = 4.5 V	6.5	10.5110		



FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- Optimized for "Low Side" Synchronous Rectifier Operation
- 100 % R_g and UIS Tested



ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

CCFL Inverter

ABSOLUTE MAXIMUM RATINGS T	$_{A}$ = 25 °C, unless other	erwise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	60	V	
Gate-Source Voltage		V_{GS}	± 20	v	
	T _C = 25 °C		7.6 ^a		
Continuous Proin Current (T = 150 °C)	T _C = 70 °C	1 , —	6.8		
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	l _D	6.1 ^{b, c}		
	T _A = 70 °C		4.8 ^{b, c}		
Pulsed Drain Current	I _{DM}	25	Α		
Ocationary Common David Divide Common	T _C = 25 °C		4.2		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	2.1 ^{b, c}		
Avalanche Current		I _{AS}	15		
Single-Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	11.2	mJ	
	T _C = 25 °C		5		
M	T _C = 70 °C		3.2	,,,	
Maximum Power Dissipation	T _A = 25 °C	P _D	2.5 ^{b, c}	W	
	T _A = 70 °C		1.6 ^{b, c}		
Operating Junction and Storage Temperature Rang	T _J , T _{stq}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	38	50	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	20	25		

Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under Steady State conditions is 85 °C/W.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static			,	•			
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		55		m\//9C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	Ι _D = 250 μΑ		- 6.3		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.2		2.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zara Cata Valtaga Drain Current	1	V _{DS} = 60 V, V _{GS} = 0 V			1		
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 60 V, V _{GS} = 0 V, T _J = 55 °C			10	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	25			Α	
	В	V _{GS} = 10 V, I _D = 4.6 A		0.025	0.030		
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 4.2 \text{ A}$		0.035	0.040	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 4.6 A		20		S	
Dynamic ^b			•	•			
Input Capacitance	C _{iss}			1100		pF	
Output Capacitance	C _{oss}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		90			
Reverse Transfer Capacitance	C _{rss}			55			
Total Cata Charra	Q _g —	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 4.6 \text{ A}$		21	32		
Total Gate Charge				10.5	16		
Gate-Source Charge	Q_{gs}	V _{DS} = 30 V, V _{GS} = 4.5 V, I _D = 4.6 A		3.5		nC	
Gate-Drain Charge	Q_{gd}			4.2		1	
Gate Resistance	R _g	f = 1 MHz		3.3	5	Ω	
Turn-On Delay Time	t _{d(on)}			20	30		
Rise Time	t _r	$V_{DD} = 30 \text{ V, R}_{L} = 5.4 \Omega$		150	225		
Turn-Off DelayTime	t _{d(off)}	$I_D \cong 5.6 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		20	30		
Fall Time	t _f	_		60	90		
Turn-On Delay Time	t _{d(on)}			10	15	ns	
Rise Time	ì,	$V_{DD} = 30 \text{ V, R}_{L} = 5.4 \Omega$		15	25	<u></u>	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong 5.6 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		25	40		
Fall Time	ì,	_		10	15		
Drain-Source Body Diode Characterist	ics			•			
Continous Source-Drain Diode Current	I _S	T _C = 25 °C			4.2	٨	
Pulse Diode Forward Current ^a	I _{SM}				25	Α	
Body Diode Voltage	V _{SD}	I _S = 2 A		0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}	-		25	50	ns	
Body Diode Reverse Recovery Charge				25	50	nC	
Reverse Recovery Fall Time	t _a	$I_F = 5.5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 \text{ °C}$		19			
Reverse Recovery Rise Time	t _b			6		ns	

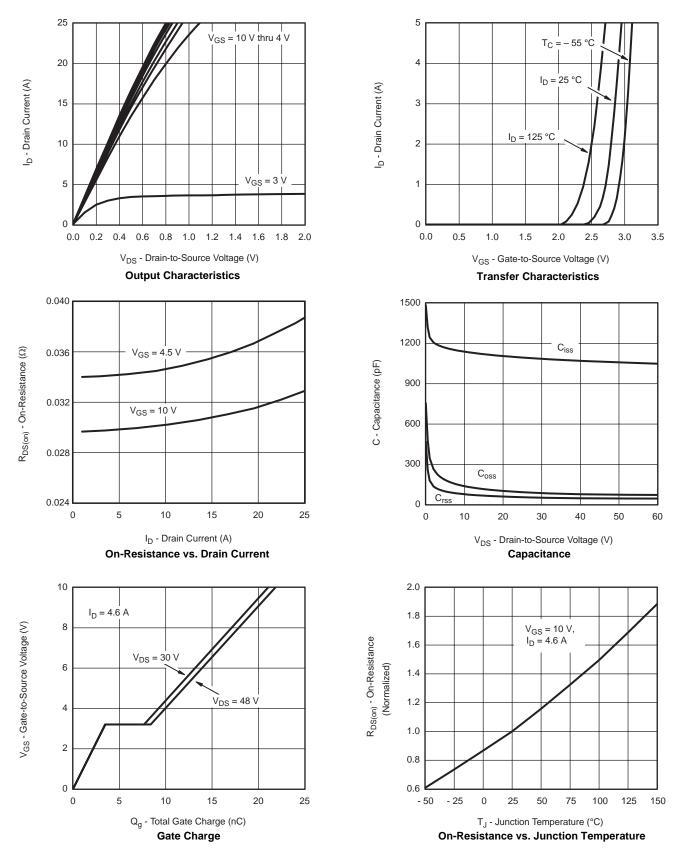
Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

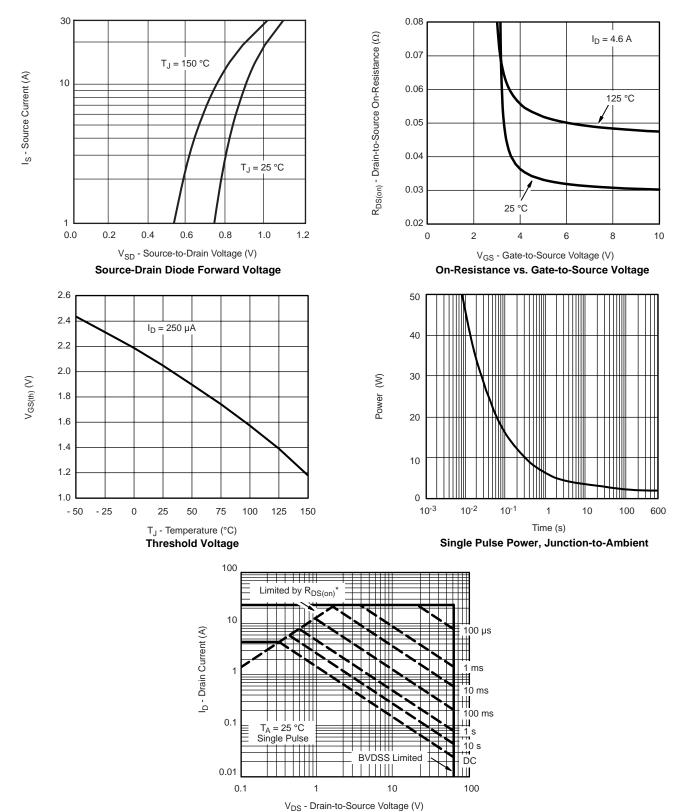
a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$

b. Guaranteed by design, not subject to production testing.



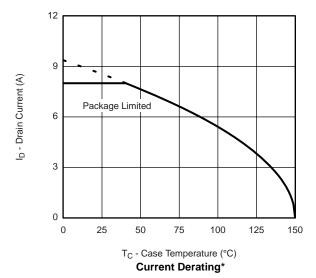


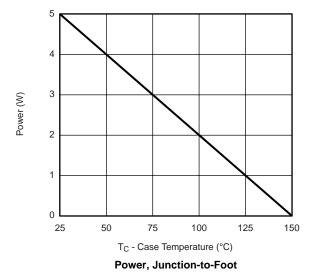




* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified **Safe Operating Area**

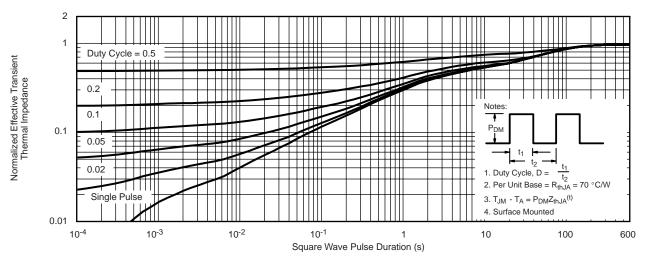




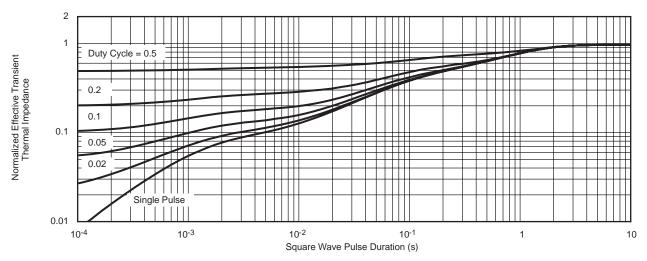


^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package





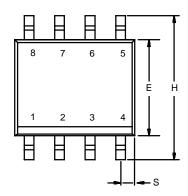
Normalized Thermal Transient Impedance, Junction-to-Ambient



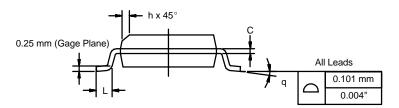
Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEADJEDEC Part Number: MS-012







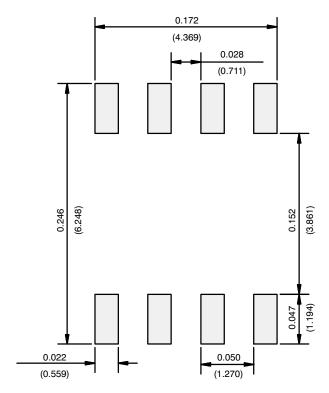
	MILLIM	IETERS	INC	HES	
DIM	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
FCN: C-06527-Rev I 11-Sen-06					

ECN: C-06527-Rev. I, 11-Sep-06

DWG: 5498



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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